Preliminary Specifications

Drawing No.	USY1M-H1-18619-00
Issued Date.	Oct,17,2018

Messrs: Digikey

Note: Part Number will be revised in case of specification change.

Product Type	Quartz Crystal
Series	CX2016DB
Frequency	38400kHz
Customer Part Number	
Customer Specification Number	
KYOCERA Part Number	CX2016DB38400F0FSRC1
Remarks Pb-Free, RoHS Compliant, MSL	1

Customer Approval			
Approval Signature		Approved Date	
		Department	
-	\wedge \mathbf{Y}	Person in charge	
		_	
			1

Seller

KYOCERA Corporation

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Manufacturer

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Design Department	Quality Assurance	Approved by	Checked by	Issued by
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Crystal Product Division				

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Revision History

Rev.No.	Description of revision	Date	Approved by	Checked by	Issued by
00	First Edition	Oct,17,2018	T.Fujii	A.Muraoka	R.Yoshida Y.Nozaki

1. APPLICATION

The purpose of this document is applied to CX2016DB quartz crystal.

2. KYOCERA PART NUMBER

CX2016DB38400F0FSRC1

3. RATINGS

Items	SYMB.	Rating	Unit	Remarks
Operating Temperature range	Topr	-40~+125	deg. C	
Storage Temperature range	Tstg	-40~+125	deg. C	

4. CHARACTERISTICS 4-1 ELECTRICAL CHARACTERISTICS

Items		Electrical Specification			Test Condition	Remarks	
	SYMB.	Min	Тур.	Max	Unit		
Mode of Vibration		F	undamenta	l			
Nominal Frequency	F0		38.4		MHz		
Nominal Temperature	T _{NOM}		25		deg. C		
Load Capacitance	CL		10.0		pF		
Frequency tolerance	df/F	-10.0	\sim	10.0	ppm	25±3deg.C	
Frequency Stability	df/t	-40.0		40.0	ppm	-40~+125deg.C	
Frequency Aging Rate	df/F	-1.0		1.0	ppm	Aging: 25deg.C	1 st year
Equivalent Series Resistance	ESR			40	Ohms	CL=SERIES	
Drive Level	Pd	0.01		100	μW		
Insulation Resistance	IR	500			M ohms	100V(DC)	

Measurement Condition

Frequency measurement

Measuring instrument : IEC PI-Network Test Fixture IEC 60444-8 STD(Pi circuit 41901A)

Equivalent series resistance (ESR) measurement

Measuring instrument: IEC PI-Network Test FixtureLoad Capacitance: Series



5. APPEARANCES, PHYSICAL DIMENSION OUTLINE DIMENSION (not to scale)

*The font of marking is for reference only.

6. RECOMMENDED LAND PATTERN (not to scale)



7. TAPING & REEL





7-3.Direction (Orientation shall be checked from the top cover tape side)



7-4.Specification

- 1. Material of the carrier tape is either polystyrene or A-PET (ESD).
- 2. Material of the cover tape is polyester (ESD).
- 3. The seal tape shall not cover the sprocket holes and not protrude from the carrier tape.
- 4. Tensile strength of carrier tape: 10N or more.
- 5. The R of the corner of each cavity is 0.2RMAX.
- 6. The alignment between centers of the cavity and sprocket hole shall be 0.05mm or less.
- 7. The orientation shall be checked from the top cover tape side as shown in 7-3.
- 8. Peeling force of cover tape: 0.1 to 1.0N.
- 9. The component will fall out naturally when cover tape is removed and set upside down.

Cover tape 165°~180 Carrier tape

7-5.Reel Specification



6330 Reel (15,000 pcs Max.)

Symbol	Р	Q	R
Dimension	ф330 <u>+</u> 2.0	φ100±1.0	φ13±0.2
Symbol	S	U	W
Dimension	φ21±0.8	2.0±0.5	9.4±1.0
			(Linite page)

(Unit: mm)

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8. Enviromental requirements

After conducting the following tests, component needs to meet below conditions. Frequency: Fluctuation within +/-10 x 10^{-6}

CI: Fluctuation within +/-20% or 5 Ω whichever is larger

8.1	Resistance to Shock	Test condition	
		3 times natural drop fr	om 100cm onto hard wooden board.
8.2	Resistance to Vibration	Test condition	
		frequency	: 10 - 55 - 10 Hz
		Amplitude	: 1.5mm
		Cycle time	: 15 minutes
		Direction	: X,Y,Z (3direction),2h each.
8.3	Resistance to Heat	Test condition	
		The quartz cryst	al unit shall be stored at a
		temperature of +	-85±2°C for 500h and subjected to
		room temperatu	re for 1h before measurement.
			× Y
8.4	Resistance to Cold	Test condition	
		The quartz cryst	al unit shall be stored at a
		temperature of -	40±2°C for 500h and subjected to
		room temperatu	re for 1h before measurement.
8.5	Thermal Shock	Test condition	
			tal unit shall be subjected to 500 temperature
			n table below,Then it shall be subjected
	(rature for 1h before mesurement.
			40±2°C (30min.)→+25±2°C(5min.)
		-	:5±2°C(30min.)→ +25±2°C(5min.)

8.6	Resistance to Moisture	Test condition
		The quartz crystal unit shall be stored at a
		temperature of +60±2°C with relative humidity of
		90% to 95% for 240 h. Then it shall be subjected
		to room temperature for 1h before measurement.

8.7 Soldering condition 1.) Type of solder

Material \rightarrow lead free solder paste Melting point \rightarrow +220±5°C

2.) Reflow temp.profile

	Temp [°C]	Time[sec]
Preheating	+150 to +180	150 (typ.)
Peak	+260±5	10 (max.)
Total	-	300 (max.)

Frequency shift : ±2ppm

- 3.) Hand Soldering +350°C 3 sec max
- 4.) Reflow Times 2 times in below Reflow temp. profile

Reflow temp.profile





Solder this product in center of the circuit board (40mm X 100mm),



UNIT : mm

9. Cautions for use

(1) Soldering upon mounting

There is a possibility to influence product characteristics when Solder paste or conductive glue comes in contact with product lid or surface.

(2) When using mounting machine

Please minimize the shock when using mounting machine to avoid any excess stress to the product.

(3) Conformity of a circuit

We strongly recommend to make sure that Negative resistance (Gain) of IC is designed to be 3 times the ESR (Equivalent Series Resistance) of crystal unit.

10. Storage conditions

Please store product in below conditions, and use within 6 months. Temperature +18 to +30°C, and Humidity of 20 to 70 % in the packaging condition.

11. Manufacturing location

KYOCERA Corporation Shiga Yohkaichi Plant KYOCERA Corporation Yamagata Higashine Plant KYOCERA Crystal Device Corporation (THAILAND)

12. Quality Assurance

Location

KYOCERA Corporation Yamagata Higashine Plant: Quality Assurance Division KYOCERA Corporation Shiga Yohkaichi Plant: Quality Assurance Division

13. Quality guarantee

In the case when KYOCERA Corporation rooted failure occurred within 1 year after its delivery, substitute product will be arranged based on discussion. Quality guarantee of product after 1 year of its delivery is waivered.

14. Others

In case of any questions or opinions regarding the Specification, please have it in written manner within 45 days after issued date.